1732

# AMENDMENT TRANSMITTAL LETTER (Large Entity)

| | Docket No. |
|---|---|
| Applicant(s): Hiroyuki Nishi et al. | **SKI.007D** |

| Serial No. 09/893,455 | APR 0 3 2003 | Filing Date June 29, 2001 | Examiner A. Ortiz | Group Art Unit 1732 |
|---|---|---|---|---|

Invention: **TRANSFER MOLDING APPARATUS AND METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICES**

RECEIVED APR 0 7 2003 GROUP 1700

## TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

### CLAIMS AS AMENDED

| | CLAIMS REMAINING AFTER AMENDMENT | HIGHEST # PREV. PAID FOR | NUMBER EXTRA CLAIMS PRESENT | RATE | ADDITIONAL FEE |
|---|---|---|---|---|---|
| TOTAL CLAIMS | 6 - | 20 = | 0 | x $18.00 | $0.00 |
| INDEP. CLAIMS | 2 - | 3 = | 0 | x $84.00 | $0.00 |
| Multiple Dependent Claims (check if applicable) ☐ | | | | | $0.00 |
| TOTAL ADDITIONAL FEE FOR THIS AMENDMENT | | | | | $0.00 |

☒ No additional fee is required for amendment.

☐ Please charge Deposit Account No.          in the amount of
   A duplicate copy of this sheet is enclosed.

☐ A check in the amount of          to cover the filing fee is enclosed.

☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No.   50-0238
   A duplicate copy of this sheet is enclosed.

   ☒ Any additional filing fees required under 37 C.F.R. 1.16.

   ☒ Any patent application processing fees under 37 CFR 1.17.

Dated:   **April 3, 2003**

_Signature_

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CC:

P11LARGE/REV06

SKI.007D

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Hiroyuki Nishi et al.                    Group Art Unit: 1732

Serial No.: 09/893,455                    Examiner: A. Ortiz

Filed: June 29, 2001

FOR:   TRANSFER MOLDING APPARATUS AND METHOD FOR
           MANUFACTURING SEMICONDUCTOR DEVICES

## RESPONSE TO ELECTION OF SPECIES REQUIREMENT

Honorable Commissioner of
      Patents and Trademarks,
Washington, D.C.  20231                    Date: April 3, 2003

Sir:

In response to the Election of Species Requirement dated March 11, 2003, the

following election, amendments and remarks are respectfully submitted in connection

with the above identified application.

**In the Abstract**

Please cancel the Abstract and replace with the Abstract attached herewith.

**In the Specification**

Kindly amend the specification as follows:

Page 1, between the title and the heading "BACKGROUND OF THE

INVENTION" insert